

Section

MV Semi-conductor

Application

Field

Laboratory



PRODUCT BENEFITS

Remove the use of knife for a increased security

TOOL CAPACITY

Diameter 10 - 80 mm
0,394 - 3,150 inch

Type of semiconductor Smooth peelable or ribbed

TOOL DIMENSIONS

Length 110 mm

Width 35 mm

Height 35 mm

Weight without box 0,13 Kg

Packaging None

Tool to remove the peelable semiconductor

TO DO WHAT

The Dsp tool allows to remove and catch the peelable semiconductor at the end of cable to remove it by hand



Associated tool

MF1+/25 - Multifunction tool for bonded semiconductor

SR - Scoring stylus for peelable semiconductor

SRC - Scoring stylus for peelable semiconductor with chamfer

MF1+/60 - Multifunction tool for bonded semiconductor

SRC-D - Scoring stylus for peelable semiconductor with chamfer on the transition

MF3/40 - Multifunction tool for outer sheath, peelable semiconductor and insulation

MF3/60 - Multifunction tool for outer sheath, peelable semiconductor and insulation



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MV cables Tools

DSP



Part Number	Diameter	Tool capacity	Dimensions			Packaging
		Type of semiconductor	Length	Width	Height	
DSP	10 - 80 mm 0,394 - 3,150 in	Smooth peelable or ribbed	110 mm 4,331 in	35 mm 1,378 in	35 mm 1,378 in	none